

Keywords:

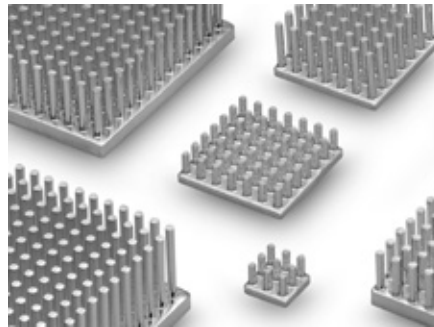
Article number:

[Search for products](#)[Back to list of products](#)**Product groups:**

- Profile heatsinks and fluid coolers
- Heatsinks and active heatsinks for processors
- Finger-shaped heatsinks
- Cooling aggregates
- Accessories for electronic components

Product group:

Heatsinks and active heatsinks for processors > Pin heatsinks

Pin heatsinks / **ICK S 36 x 36 x 10** 

36 x 36 x 10 mm, pin heatsinks quadratic

Parameters of article ICK S 36 x 36 x 10

Bauform	Rechteck
R_{th} [K / W]	4.7
dissipation loss [W]	16
mounting method	therm. conductive foil / therm. cond. adhesive
socket	universal
suitable for processor type	universal
width [mm]	36.4
height [mm]	10
plate thickness [mm]	3.5
weight [g]	17
length on stock [mm]	36.4

 Technical
 Drawing
Accessories / related articlesThermally conductive foil both sides adhesive / **WLFT 404 36 x 36**Thermally conductive foil both sides adhesive / **WLFT 405 36 x 36****Download CAD Drawing**

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